

Product data sheet

1. General description

Dual ultrafast power diode in a SOT429 (3-lead TO-247) plastic package.

2. Features and benefits

- Very low on-state loss
- Fast switching
- Low leakage current
- Low thermal resistance

3. Applications

- Active PFC in air conditioner
- Interleaved PFC topology in switched-mode power supplies

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _R	reverse voltage	DC	-	-	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 127 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-	-	15	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 127 °C; Square-ware pulse	-	-	30	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	-	-	150	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	-	-	165	A
Static chara	acteristics					
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.4	2.1	V
		I _F = 15 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.1	1.8	V
Dynamic ch	naracteristics					
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	25	50	ns
		I_F = 15 A; V _R = 400 V; dI _F /dt = 200 A/ µs; T _j = 25 °C; <u>Fig. 7</u>	-	45	-	ns
		I _F = 15 A; V _R = 400 V; dI _F /dt = 200 A/ μs; T _j = 125 °C; <u>Fig. 7</u>	-	65	-	ns

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		$I_F = 15 \text{ A}; V_R = 400 \text{ V}; dI_F/\text{d}t = 500 \text{ A}/ \\ \mu \text{s}; T_j = 25 ^\circ\text{C}; \underline{\text{Fig. } 7}$	-	34	-	ns

5. Pinning information

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Table 2.	Pinning in	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		
2	К	cathode		
3	A2	anode 2		K sym125
mb	mb	mounting base; connected to cathode		
			TO-247 (SOT429)	

6. Ordering information

Table 3. Ordering inform	mation				
Type number	Package				
	Name	Description	Version		
BYV415W-600P	TO-247	plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3 lead TO-247	SOT429		

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	600	V
V _{RWM}	crest working reverse voltage		-	600	V
V _R	reverse voltage	DC	-	600	V
I _{F(AV)}	average forward current	$\delta = 0.5$; $T_{mb} \le 127$ °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-	15	A
I _{O(AV)}	average output current	$\delta = 0.5$; T _{mb} \leq 117 °C; square-wave pulse; both diodes conducting	-	30	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 127 °C; Square-ware pulse	-	30	A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; per diode; <u>Fig. 4</u>	-	150	A
		t _p = 8.3 ms; T _{j(init)} = 25 °C; sine-wave pulse; per diode; <u>Fig. 4</u>	-	165	A
T _{stg}	storage temperature		-65	175	°C
Tj	junction temperature		-	175	°C

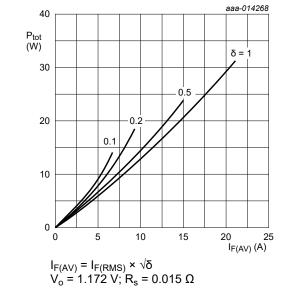
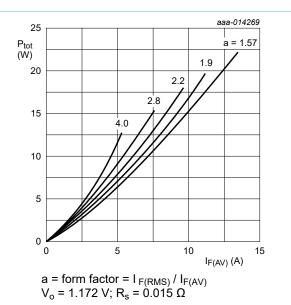


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

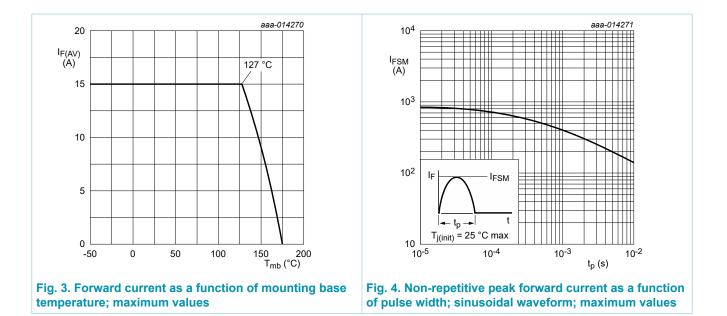




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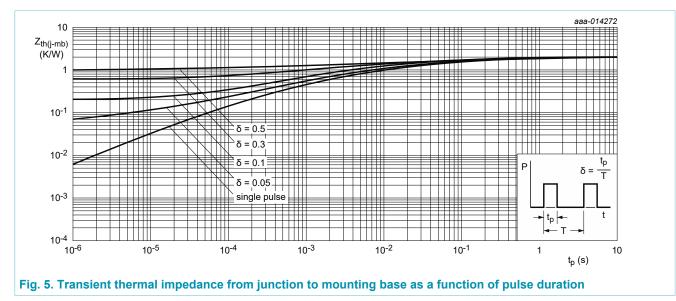
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8. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	with heatsink compound; per diode; Fig. 5	-	1.2	2	K/W
		with heatsink compound; both diodes conducting	-	0.65	1.2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



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9. Characteristics

Table 6. Characteristics

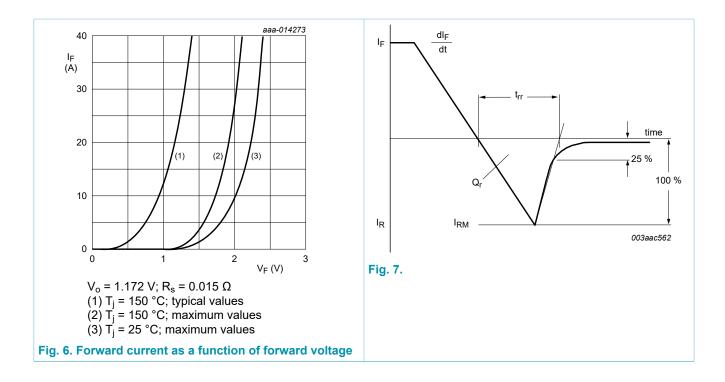
characteristics are per diode unless otherwise stated

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _F	forward voltage	I _F = 15 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.4	2.1	V
		I _F = 15 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.1	1.8	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	10	μA
		V _R = 600 V; T _j = 150 °C	-	-	500	μA
Dynamic ch	naracteristics					
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	25	50	ns
		I_F = 15 A; V_R = 400 V; dI_F/dt = 200 A/ µs; T_j = 25 °C; Fig. 7	-	45	-	ns
		I_F = 15 A; V_R = 400 V; dI_F/dt = 200 A/ µs; T_j = 125 °C; <u>Fig. 7</u>	-	65	-	ns
		I_F = 15 A; V_R = 400 V; dI_F/dt = 500 A/ µs; T_j = 25 °C; Fig. 7	-	34	-	ns
I _{RM}	peak reverse recovery current	I_F = 15 A; V_R = 400 V; dI_F/dt = 200 A/ µs; T_j = 25 °C; <u>Fig. 7</u>	-	5.5	-	A
		I_F = 15 A; V_R = 400 V; dI_F/dt = 200 A/ µs; T_j = 125 °C; <u>Fig. 7</u>	-	9.7	-	A
Qr	recovered charge	I_F = 15 A; V_R = 400 V; dI_F/dt = 200 A/ µs; T_j = 25 °C; Fig. 7	-	125	-	nC
		I_F = 15 A; V_R = 400 V; dI_F/dt = 200 A/ µs; T_j = 125 °C; <u>Fig. 7</u>	-	318	-	nC

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10. Package outline

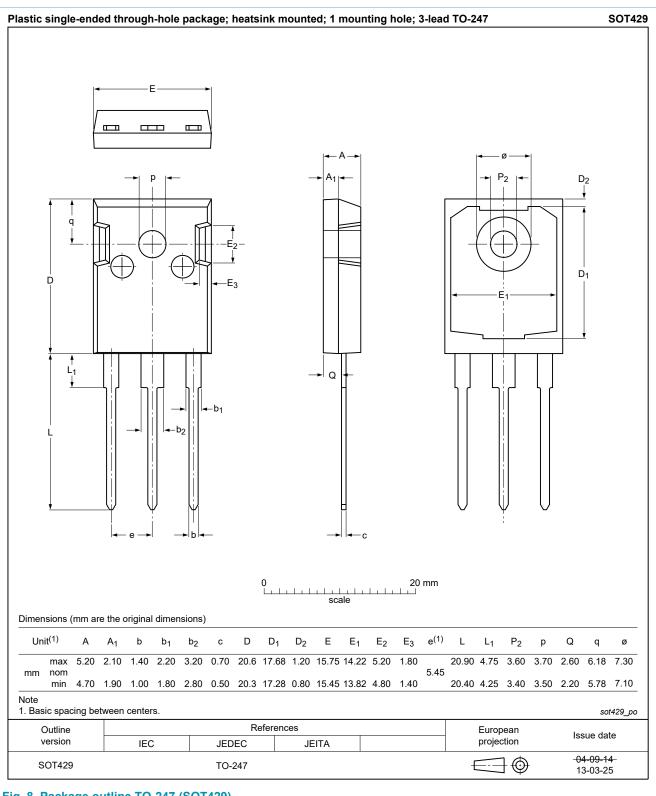


Fig. 8. Package outline TO-247 (SOT429)

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11. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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